Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Device	V _Z (V) @ I _Z (Note 1)			Test Current	Max. Zener Impedance			Leakage Current	
	Min.	Тур.	Max.	I _Z (mA)	Z _Z @ I _Z (Ω)	Z _{ZK} @ I _{ZK} (Ω)	I _{ZK} (mA)	Ι _R (μ A)	V _R (V)
1N4748A	20.9	22	23.1	11.5	23	750	0.25	5	16.7
1N4749A	22.8	24	25.2	10.5	25	750	0.25	5	18.2
1N4750A	25.65	27	28.35	9.5	35	750	0.25	5	20.6
1N4751A	28.5	30	31.5	8.5	40	1000	0.25	5	22.8
1N4752A	31.35	33	34.65	7.5	45	1000	0.25	5	25.1
1N4753A	34.2	36	37.8	7	50	1000	0.25	5	27.4
1N4754A	37.05	39	40.95	6.5	60	1000	0.25	5	29.7
1N4755A	40.85	43	45.15	6	70	1500	0.25	5	32.7
1N4756A	44.65	47	49.35	5.5	80	1500	0.25	5	35.8
1N4757A	48.45	51	53.55	5	95	1500	0.25	5	38.8
1N4758A	53.2	56	58.8	4.5	110	2000	0.25	5	42.6
1N4759A	58.9	62	65.1	4	125	2000	0.25	5	47.1
1N4760A	64.6	68	71.4	3.7	150	2000	0.25	5	51.7
1N4761A	71.25	75	78.75	3.3	175	2000	0.25	5	56
1N4762A	77.9	82	86.1	3	200	3000	0.25	5	62.2
1N4763A	86.45	91	95.55	2.8	250	3000	0.25	5	69.2
1N4764A	95	100	105	2.5	350	3000	0.25	5	76

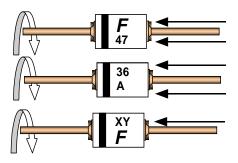
Notes:

^{1.} Zener Voltage (V_Z)
The zener voltage is measured with the device junction in the thermal equilibrium at the lead temperature (T_L) at 30°C ± 1°C and 3/8" lead length.

Top Mark Information

Device	Line 1	Line 2	Line 3	Line 4	Line 5
1N4728A	LOGO	47	28	Α	XY
1N4729A	LOGO	47	29	Α	XY
1N4730A	LOGO	47	30	Α	XY
1N4731A	LOGO	47	31	Α	XY
1N4732A	LOGO	47	32	Α	XY
1N4733A	LOGO	47	33	Α	XY
1N4734A	LOGO	47	34	Α	XY
1N4735A	LOGO	47	35	Α	XY
1N4736A	LOGO	47	36	Α	XY
1N4737A	LOGO	47	37	Α	XY
1N4738A	LOGO	47	38	Α	XY
1N4739A	LOGO	47	39	Α	XY
1N4740A	LOGO	47	40	Α	XY
1N4741A	LOGO	47	41	Α	XY
1N4742A	LOGO	47	42	Α	XY
1N4743A	LOGO	47	43	А	XY
1N4744A	LOGO	47	44	Α	XY
1N4745A	LOGO	47	45	Α	XY
1N4746A	LOGO	47	46	Α	XY
1N4747A	LOGO	47	47	Α	XY
1N4748A	LOGO	47	48	Α	XY
1N4749A	LOGO	47	49	Α	XY
1N4750A	LOGO	47	50	Α	XY
1N4751A	LOGO	47	51	Α	XY
1N4752A	LOGO	47	52	Α	XY
1N4753A	LOGO	47	53	Α	XY
1N4754A	LOGO	47	54	Α	XY
1N4755A	LOGO	47	55	Α	XY
1N4756A	LOGO	47	56	Α	XY
1N4757A	LOGO	47	57	Α	XY
1N4758A	LOGO	47	58	Α	XY
1N4759A	LOGO	47	59	Α	XY
1N4760A	LOGO	47	60	Α	XY
1N4761A	LOGO	47	61	Α	XY
1N4762A	LOGO	47	62	Α	XY
1N4763A	LOGO	47	63	Α	XY
1N4764A	LOGO	47	64	Α	XY

Top Mark Information (Continued)



1st line: F - Fairchild Logo

2nd line: Device Name - 3rd to 4th characters of device name for 1Nxx series or 4th to 6th characters for BZXyy series

3rd line: Device Name - 5th to 6th characters of device name for 1Nxx series or Voltage rating for BZXyy series

4th line: Device Name - 7th to 8th characters of device name for 1Nxx series or Large Die identification only for BZXyy series

5th line: Date Code - Two Digit - Six Weeks Date Code

General Requirements:

- 1.0 Cathod Band
- 2.0 First Line: F Fairchild Logo
- 3.0 Second Line: Device name For 1Nxx series: 3^{rd} to 4^{th} characters of the device name. For BZxx series: 4^{th} to 6^{th} characters of the device name.
- 4.0 Third Line: Device name For 1Nxx series: 5^{th} to 6^{th} characters of the device name.

For BZXyy series: Voltage rating

5.0 Third Line: Device name - For 1Nxx series: 7th to 8th characters of the device name. (the 8th character is the large die identification)

For BZXyy series: Large Die Identification character

6.0 Fourth Line: Date Code - Two Digit - Six Weeks Date Code

Where: X represents the last digit of the calendar year

Y represents the Six weeks numeric code

- 7.0 Devices shall be marked as required in the device specification (PID or FSC Test Spec).
- 8.0 Maximum no. of marking lines: 5
- 9.0 Maximum no. of digits per line: 3
- 10.0 FSC logo must be 20 % taller than the alphanumeric marking and should occupy the 2 characters of the specified line.
- 11.0 Marking Font: Arial (Except FSC Logo)
- 12.0 First character of each marking line must be aligned vertically

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1N4728A - 1N4764A Rev. G2

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CoolFET™	FRFET™	MICROCOUPLER™	PowerSaver™	SuperSOT™-3
$CROSSVOLT^{TM}$	GlobalOptoisolator™	MicroFET™	PowerTrench [®]	SuperSOT™-6
DOME™	GTO™	MicroPak™	QFET [®]	SuperSOT™-8
EcoSPARK™	HiSeC™	MICROWIRE™	QS™	SyncFET™
E ² CMOS™	I^2C^{TM}	MSX™	QT Optoelectronics™	TinyLogic [®]
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FACT™	ImpliedDisconnect™	OCX™	RapidConfigure™	TruTranslation™
FACT Quiet Series™		OCXPro™	RapidConnect™	UHC™
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Programmable Active Droop™		PACMAN™	SMART START™	VCX TM

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.		
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.		

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